

GUJARAT TECHNOLOGICAL UNIVERSITY**ME Semester –I Examination Feb. - 2012****Subject code: 710412N****Date: 18/02/2012****Subject Name: Digital VLSI Design****Time: 10.30 am – 01.00 pm****Total Marks: 70****Instructions:**

1. Attempt all questions.
2. Make suitable assumptions wherever necessary.
3. Figures to the right indicate full marks.

- Q.1** (a) Explain VLSI design flow with necessary diagrams and explain the concepts of regularity, modularity and locality with suitable example. **07**
- (b) Discuss fabrication process of NMOS transistor in detail with required diagram. **07**

- Q.2** (a) Draw energy band diagram of the combined MOS system. Explain MOS system under different external bias voltage with energy band diagram. **07**
- (b) Derive the MOSFET drain current equation while MOSFET is operating in linear region. Draw the current-voltage characteristics of the MOSFET and explain in detail. **07**

OR

- (b) Calculate the threshold voltage V_{T0} at $V_{SB} = 0$, for a polysilicon gate n-channel MOS transistor, with the following parameters: substrate doping density $N_A = 10^{16} \text{ cm}^{-3}$, polysilicon gate doping density $N_D = 2 \times 10^{20} \text{ cm}^{-3}$, gate oxide thickness $t_{ox} = 500 \text{ \AA}$, and oxide-interface fixed charge density $N_{ox} = 4 \times 10^{10} \text{ cm}^{-2}$.
At room temperature, i.e., $T = 300 \text{ K}$, take $n_i = 1.45 \times 10^{10} \text{ cm}^{-3}$, Boltzmann constant $= 1.38 \times 10^{-23} \text{ J/K}$, Electron charge $= 1.6 \times 10^{-19} \text{ C}$, Relative permittivity of Si $= 11.68$, Relative permittivity of Silicon dioxide $= 3.97$, and $\epsilon_0 = 8.85 \times 10^{-14} \text{ F/cm}$. Assume ϕ_F (gate) $= 0.55 \text{ V}$ **07**

- Q.3** (a) Draw the resistive-load nMOS inverter circuit and the voltage transfer characteristics with important points. Find the equation of all the critical voltages for the circuit. **07**
- (b) Consider a resistive-load inverter with $V_{DD} = 5 \text{ V}$, $k_n' = 20 \mu\text{A/V}^2$, $V_{T0} = 0.8 \text{ V}$, $R_L = 200 \text{ k}\Omega$ and $W/L = 2$. Calculate the critical voltages (V_{OL} , V_{OH} , V_{IL} , and V_{IH}) on the VTC and find the noise margins of the circuits. **07**

OR

- Q.3** (a) Draw and explain the CMOS inverter. Find the V_{IL} , V_{IH} and V_{th} equation for the same. **07**
- (b) Consider a CMOS inverter circuit with the following parameters: **07**
 $V_{DD} = 3.3 \text{ V}$,
 For NMOS, $V_{T0, n} = 0.6 \text{ V}$, $k_n = 200 \mu\text{A/V}^2$
 For PMOS, $V_{T0, p} = -0.7 \text{ V}$, $k_p = 80 \mu\text{A/V}^2$
 Calculate noise margin of the circuit considering $k_R = 2.5$

Q.4	(a)	Explain the behavioral of bistable elements	07
	(b)	Answer the following questions	
	1.	Draw the circuit diagram of CMOS implementation of D-latch along with the simplified view. Also explain the timing diagram of it.	03
	2.	Explain voltage bootstrapping.	04
OR			
Q.4	(a)	Calculate the delay time for CMOS inverter during its high to low transition.	07
	(b)	Explain CMOS transmission gate (Pass gates) with different region.	07
Q.5	(a)	Explain with circuit two input CMOS NOR and NAND gate. Also derive threshold voltage for both.	07
	(b)	Answer the following questions	
	1.	Realised following Boolean equation using CMOS transmission gates $F=AB+A'C'+AB'C$	03
	2.	Draw Six-transistor CMOS transmission gate implementation of the XOR function	02
	3.	Realised following Boolean function using CMOS. $F=AB+C(D+E)$	02
OR			
Q.5	(a)	Explain basic principle of pass transistor with logic “1” transfer and logic “0” transfer. And plot the curve of output voltage in both the case.	07
	(b)	By taking suitable examples, discuss the ratioed and ratio-less dynamic logic circuits	07
